

NPN SILICON TRANSISTOR

NPN SILICON POWER TRANSISTORS

DESCRIPTION

These devices are designed for high-voltage, high-speed power switching inductive circuits where fall time is critical. They are particularly suited for 115 and 220 V SWITCHMODE.

FEATURES

- * V_{CEO(SUS)}= 400V
- * Reverse bias SOA with inductive loads @ T_c = 100°C
- * Inductive switching matrix 2 to 4 Amp, 25 and 100°C
- t_C @ 3A, 100°C is 180 ns (Typ)
- * 700V blocking capability
- * SOA and switching applications information

APPLICATIONS

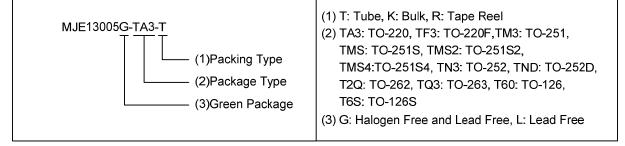
- * Switching regulator's, inverters
- * Motor controls
- * Solenoid/Relay drivers
- * Deflection circuits

ORDERING INFORMATION

1	1	1
TO-220	TO-220F	TO-251
1	1	1
1	1/1/1	
TO-252	TO-252D	TO-262
1 TO-263	کار ا	1 TO-126S

Ordering Number		Dookogo	Pin Assignment			Dooking
Lead Free	Halogen Free	Package	1	2	3	Packing
MJE13005L-TA3-T	MJE13005G-TA3-T	TO-220	В	С	Е	Tube
MJE13005L-TF3-T	MJE13005G-TF3-T	TO-220F	В	С	Е	Tube
MJE13005L-TM3-T	MJE13005G-TM3-T	TO-251	В	С	Е	Tube
MJE13005L-TMS-T	MJE13005G-TMS-T	TO-251S	В	С	Е	Tube
MJE13005L-TMS2-T	MJE13005G-TMS2-T	TO-251S2	В	С	E	Tube
MJE13005L-TMS4-T	MJE13005G-TMS4-T	TO-251S4	В	С	E	Tube
MJE13005L-TN3-R	MJE13005G-TN3-R	TO-252	В	С	E	Tape Reel
MJE13005L-TND-R	MJE13005G-TND-R	TO-252D	В	С	E	Tape Reel
MJE13005L-T2Q-T	MJE13005G-T2Q-T	TO-262	В	С	E	Tube
MJE13005L-TQ3-T	MJE13005G-TQ3-T	TO-263	В	С	E	Tube
MJE13005L-TQ3-R	MJE13005G-TQ3-R	TO-263	В	С	E	Tape Reel
MJE13005L-T60-K	MJE13005G-T60-K	TO-126	В	С	Е	Bulk
MJE13005L-T6S-K	MJE13005G-T6S-K	TO-126S	В	С	Е	Bulk
Nato: Din Assignment: D: Dass. C: Collector. E: Emitter						

Note: Pin Assignment: B: Base C: Collector E: Emitter



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MARKING

PACKAGE		MARKING	
TO-220 TO-220F TO-251 TO-251S TO-251S2	TO-251S4 TO-252 TO-252D TO-262 TO-263	UTC MJE13005 G: Halogen Free Lot Code	
TO-126 TO-126S		UTC DDD MJE13005 L: Lead Free 1 G: Halogen Free	



■ ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT
Collector-Emitter Voltage		V _{CEO(SUS)}	400	V
Collector-Emitter Voltage (V _{BE} =0)		V _{CES}	700	V
Collector-Base Voltage		V _{CBO}	700	V
Emitter Base Voltage		V _{EBO}	9	V
Collector Current	Continuous	Ι _C	4	А
Collector Current	Peak (1)	I _{CM}	8	А
Read Current	Continuous	Ι _Β	2	А
Base Current	Peak (1)	I _{BM}	4	А
Emitter Current	Continuous	IE	6	А
Emiller Current	Peak (1)	I _{EM}	12	А
Power Dissipation at T _C =25°C	TO-126/TO-126S TO-220F		40	
	TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D		50	w
	TO-220/TO-263 TO-262	Pp	75	
Derate above 25°C	TO-126/TO-126S TO-220F	FD	320	
	TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D		400	mW/°C
	TO-220/TO-263 TO-262		600	
Operating and Storage Junction Temperature		T _J , T _{STG}	-65 ~ +150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
	TO-126/TO-126S		89	
	TO-251/TO-251S	4 θ _{JA}		
Junction to Ambient	TO-251S2/TO-251S4		80	°C/W
	TO-252/TO-252D			0/11
	TO-220/TO-263		62.5	
	TO-262/TO-220F		02:5	
	TO-126/TO-126S		3.125	
	TO-220F		5.125	
	TO-251/TO-251S			
Junction to Case	TO-251S2/TO-251S4	θ _{JC}	2.5	°C/W
	TO-252/TO-252D			
	TO-220/TO-263		1.67	
	TO-262		1.07	



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS (Note 1)							
Collector-Emitter Sustaining Voltage	V _{CEO(SUS)}	I _C =10mA , I _B =0	400			V	
Collector Cutoff Current	I _{сво}	V _{CBO} =Rated Value, V _{BE(OFF)} =1.5V			1	- mA	
		V _{CBO} =Rated Value, V _{BE(OFF)} =1.5V, T _C =100°C			5		
Emitter Cutoff Current	I _{EBO}	V _{EB} =9V, I _C =0			1	mA	
SECOND BREAKDOWN							
Second Breakdown Collector Current with bass forward biased	I _{S/B}		See Fig. 11			11	
Clamped Inductive SOA with Base Reverse Biased	RBSOA		See Fig. 12			12	
ON CHARACTERISTICS (Note 1)							
DC Current Gain	h _{FE1}	I _C =0.5A, V _{CE} =5V	20		40		
	h _{FE2}	I _C =1A, V _{CE} =5V	10		60		
	h _{FE3}	I _C =2A, V _{CE} =5V	8		40		
	V _{CE(SAT)}	I _C =1A, I _B =0.2A			0.5	V	
Collector-Emitter Saturation Voltage		I _C =2A, I _B =0.5A			0.6	V	
		I _C =4A, I _B =1A			1	V	
		I _C =2A, I _B =0.5A, Ta=100°C			1	V	
	V _{BE (SAT)}	I _C =1A, I _B =0.2A			1.2	V	
Base-Emitter Saturation Voltage		I _C =2A, I _B =0.5A			1.6	V	
		I _C =2A, I _B =0.5A, T _C =100°C			1.5	V	
DYNAMIC CHARACTERISTICS							
Current-Gain-Bandwidth Product	f⊤	I _C =500mA, V _{CE} =10V, f=1MHz	4			MHz	
Output Capacitance	C _{OB}	V _{CB} =10V, I _E =0, f=0.1MHz		65		pF	
SWITCHING CHARACTERISTICS							
Resistive Load (Table 1)							
Delay Time	t _D			0.025	0.1	μs	
Rise Time	t _R	V_{CC} =125V, I_{C} =2A, I_{B1} = I_{B2} =0.4A,		0.3	0.7	μs	
Storage Time	ts	t _P =25µs, Duty Cycle≤1%		1.7	4	μs	
Fall Time	t⊨			0.4	0.9	μs	

■ ELECTRICAL CHARACTERISTICS (T_c=25°C, unless otherwise specified)

Note: 1. Pulse Test: Pulse Width = 5ms, Duty Cycle ≤ 10%

2. Pulse Test: P_W = 300µs, Duty Cycle ≤ 2%



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APPLICATION INFORMATION

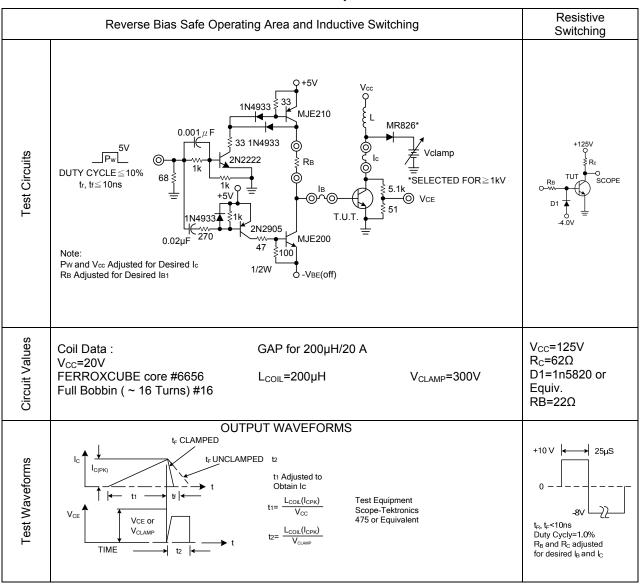
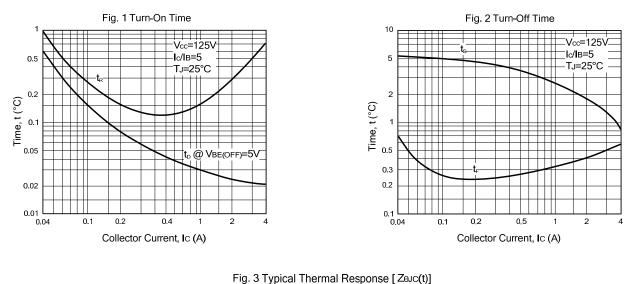


Table 1.Test Conditions for Dynamic Performance

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RESISTIVE SWITCHING PERFORMANCE



1 Transient Thermal Resistance, r(t) (Normalized) H 0.7 D=0.5 0.5 + 0.3 0.2 0.2 ⁻0.'1 0.1 Р (РК) 0.05 Zeuc(t)=r(t) Reuc Reuc=1.67°C/W MAX 0.07 T 0.05 D CURVES APPLY FOR POWER PULSE TRAIN SHOWN 0.02 0.03 t1 I∙ READ TIME AT t1 - t2 · 0.02 0.01 Tj(pk)-TC=P(pk) ZUJC(t) DUTY CYCLE, D=t1/t2 SINGLE PULSE 0.01 20 50 10 0 0.02 0.05 0.2 2 5 50 0.1 10 0.5 1 20 1k 0.01 0 0 Time, t (ms)

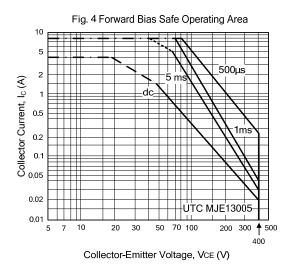
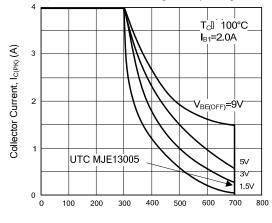


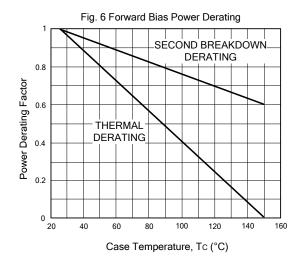
Fig. 5 Reverse Bias Switching Safe Operating Area



Collector-Emitter Clamp Voltage, VCE (V)



RESISTIVE SWITCHING PERFORMANCE(Cont.)





SAFE OPERATING AREA INFORMATION

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_{C}-V_{CE}$ limits of the transistor that must be observed for reliable operation; e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Fig. 4 is based on $T_C = 25^{\circ}C$; $T_{J(PK)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \ge 25^{\circ}C$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Fig. 4 may be found at any case temperature by using the appropriate curve on Fig. 6.

 $T_{J(PK)}$ may be calculated from the data in Fig. 10. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

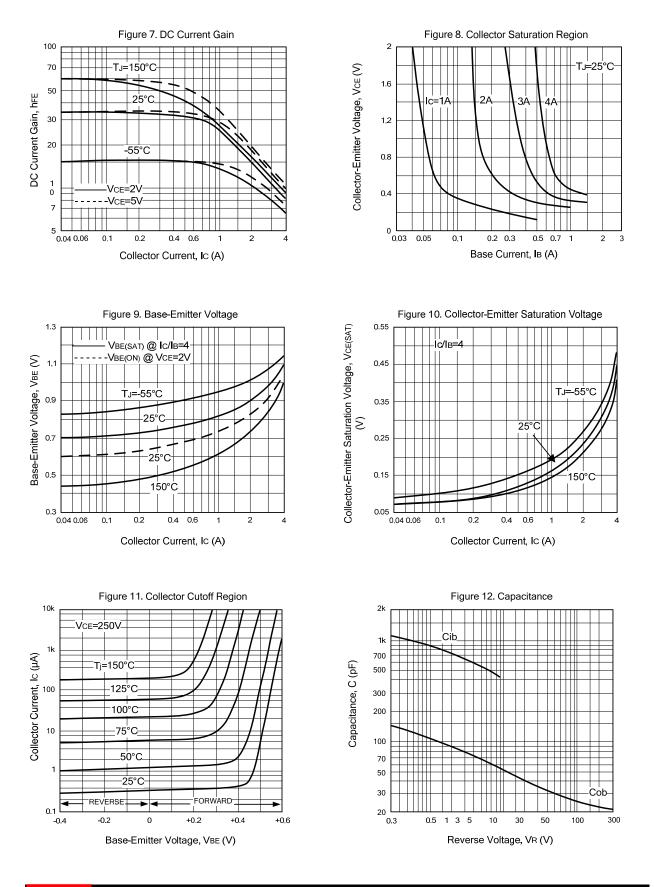
REVERSE BIAS

For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage-current conditions during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 5 gives the complete RBSOA characteristics.



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TYPICAL CHARACTERISTICS





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